



## Kimya PLA-HI 3D Filament

The Kimya **PLA-HI** 3D filament is a biosourced polymer obtained from corn starch. Polylactic Acid -HI (**PLA-HI**) is a "High Impact" filament offering increased impact resistance: it was formulated to be four times more resistant to impact than standard PLA. PLA is easy to print and is odorless. It can be used to create functional prototypes, spare parts, architectural models and in other forms of modeling. The Kimya PLA-HI 3D filament has the following properties:

- Easy to print
- Impact resistance
- Odorless
- Biosourced material
- Food contact under EU10/2011
- Complies with the **REACH standard**

2-year KIMYA warranty.

## **FILAMENT PROPERTIES**

PROPERTIES	TEST METHODS	VALUES
Diameter	INS-6712	1.75 ± 0.1 mm 2.85 ± 0.1 mm
Density	ISO 1183-1	1.21 g/cm3
Moisture rate	INS-6711	< 0.5 %
Melt flow index (MFI)	ISO 1133-1 (@210°C - 2,16 kg)	5.7 g/10min
Glass transition temperature (Tg)	ISO 11357-1 DSC (10°C/min - 20-300°C)	107 °C
Melting Temperature (Tm)	ISO 11357-1 DSC (10°C/min – 20-220°C)	156 ℃

## PRINT PARAMETERS AND SPECIMENS DIMENSIONS

PRINTING DIRECTION	XY	
Printing Speed	40-150 mm/s	
Infill	100% - rectilinear	
Infill Angle	45°/-45°	
Nozzle Temperature	190-210°C	
Bed T°	20-60°C	

## **PRINTED SPECIMENS PROPERTIES**

		PROPERTIES	TEST METHODS	VALUES	
MECHANICAL PROPERTIES		Tensile modulus	ISO 527-2/5A/50	2,491 MPa	
		Tensile Strength	ISO 527-2/5A/50	43 MPa	
		Tensile strain at strength	ISO 527-2/5A/50	2 %	
		Tensile Stress at Break	ISO 527-2/5A/50	22.9 MPa	
	NICAL	Tensile strain at break (type A)	ISO 527-2/5A/50	4.2 %	
	Flexural modulus	ISO 178	2,097 MPa		
		Deformation at Flexural Strain	ISO 178	>5 %	
		Flexural stress at conventional deflection (3,5% strain)*	ISO 178	62.8 MPa	
		Charpy impact resistance	ISO 179-1/1eA	16.5 kJ/m <sup>2</sup>	
		Shore Hardness	ISO 868	76,8D	
Note 1	*According to ISO 178, end of the test at 5% deformation even if there is no specimen break.				
Note 2	The data should be considered as indicative values - Properties can be influenced by production conditions.				

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